

AUTOMOTIVE GRADE

AUIRF7341Q

Features

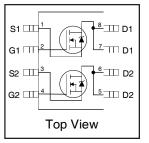
- Advanced Planar Technology
- Ultra Low On-Resistance
- Logic Level Gate Drive
- Dual N Channel MOSFET
- Surface Mount
- Available in Tape & Reel
- 175°C Operating Temperature
- Automotive [Q101] Qualified*
- Lead-Free, RoHS Compliant

Description

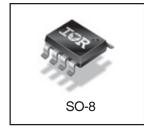
Specifically designed for Automotive applications, these HEXFET® Power MOSFET's in a Dual SO-8 package utilize the lastest processing techniques to achieve extremely low onresistance per silicon area. Additional features of these Automotive qualified HEXFET Power MOSFET's are a 175°C junction operating temperature, fast switching speed and improved repetitive avalanche rating. These benefits combine to make this design an extremely efficient and reliable device for use in Automotive applications and a wide variety of other applications.

The efficient SO-8 package provides enhanced thermal characteristics and dual MOSFET die capability making it ideal in a variety of power applications. This dual, surface mount SO-8 can dramatically reduce board space and is also available in Tape & Reel.

HEXFET® Power MOSFET



V _{(BR)DSS}		55V
R _{DS(on)}	typ.	0.043Ω
	max.	0.050Ω
I _D		5.1A



G	D	S
Gate	Drain	Source

Base Part Number	Dookogo Typo	Standard P	ack	Orderable Part Number	
base Part Number	Package Type	Form	Quantity		
AUIRF7341Q	SO-8	Tube	95	AUIRF7341Q	
AUINF/34 IQ	30-8	Tape and Reel	4000	AUIRF7341QTR	

Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only; and functional operation of the device at these or any other condition beyond those indicated in the specifications is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions. Ambient temperature (T_A) is 25°C, unless otherwise specified.

	Parameter	Max.	Units	
V _{DS} Drain-Source Voltage		55	V	
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 10V	5.1		
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 10V	4.2	Α	
I _{DM}	Pulsed Drain Current ①	42	1	
P _D @T _A = 25°C	Power Dissipation3	2.4	w	
P _D @T _A = 70°C	Power Dissipation [®]	1.7	VV	
	Linear Derating Factor	16	mW/°C	
V _{GS}	Gate-to-Source Voltage	± 20	V	
E _{AS}	Single Pulse Avalanche Energy ②	140	mJ	
I _{AR}	Avalanche Current	5.1	А	
E _{AR}	Repetitive Avalanche Energy	See Fig. 16,17,14a, 14b	mJ	
TJ	Operating Junction and	55 to 1 175	°C	
T _{STG}	Storage Temperature Range	-55 to + 175		

Thermal Resistance

	Parameter	Max.	Units
Bala	Junction-to-Ambient @	62.5	°C/W

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^{*}Qualification standards can be found at http://www.irf.com/



Static Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	55			٧	$V_{GS} = 0V, I_D = 250\mu A$
$\Delta V_{(BR)DSS}/\Delta T_J$	Breakdown Voltage Temp. Coefficient		0.052		V/°C	Reference to 25°C, I _D = 1mA
D	Static Drain-to-Source On-Resistance		0.043	0.050		$V_{GS} = 10V, I_D = 5.1A$ ③
R _{DS(on)}	tatic Drain-to-Source On-Resistance		0.056	0.065	Ω	$V_{GS} = 4.5V, I_D = 4.42A$
V _{GS(th)}	Gate Threshold Voltage	1.0		3.0	٧	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
gfs	Forward Transconductance	10.4			S	$V_{DS} = 10V, I_{D} = 5.2A$
I _{DSS}	Drain-to-Source Leakage Current			2.0		$V_{DS} = 44V$, $V_{GS} = 0V$
				25	μA	$V_{DS} = 44V, V_{GS} = 0V, T_{J} = 150^{\circ}C$
I _{GSS}	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 20V
	Gate-to-Source Reverse Leakage			-100	l IIA	V _{GS} = -20V

Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
Q_g	Total Gate Charge		29	44		$I_D = 5.2A$
Q_{gs}	Gate-to-Source Charge		2.9	4.4	nC	$V_{DS} = 44V$
Q_{gd}	Gate-to-Drain ("Miller") Charge		7.3	11	1	$V_{GS} = 10V$
t _{d(on)}	Turn-On Delay Time		9.2			$V_{DD} = 28V$
t _r	Rise Time		7.7]	$I_D = 1.0A$
t _{d(off)}	Turn-Off Delay Time		31		ns	$R_G = 6.0\Omega$
t _f	Fall Time		12.5		1	V _{GS} = 10V ③
C _{iss}	Input Capacitance		780			$V_{GS} = 0V$
C _{oss}	Output Capacitance		190		pF	$V_{DS} = 25V$
C _{rss}	Reverse Transfer Capacitance		66]	f = 1.0MHz

Diode Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			0.4		MOSFET symbol
	(Body Diode)			2.4	١ , ١	showing the
I _{SM}	Pulsed Source Current			40	A	integral reverse
	(Body Diode) ①			42		p-n junction diode.
V _{SD}	Diode Forward Voltage			1.2	V	$T_J = 25^{\circ}C, I_S = 2.6A, V_{GS} = 0V$ ③
t _{rr}	Reverse Recovery Time		51	77		$T_J = 25^{\circ}C, I_F = 2.6A$
Q _{rr}	Reverse Recovery Charge		76	114	nC	di/dt = 100A/µs ③

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- $@\ V_{DD}$ = 25V, starting T_J = 25°C, L = 10.7mH, R_G = 25 Ω , I_{AS} = 5.2A.
- ③ Pulse width ≤ 300 μ s; duty cycle ≤ 2%.
- 4 Surface mounted on FR-4 board, $t \le 10 \text{sec.}$



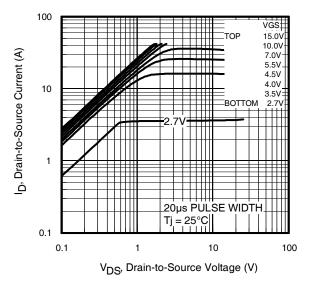


Fig 1. Typical Output Characteristics

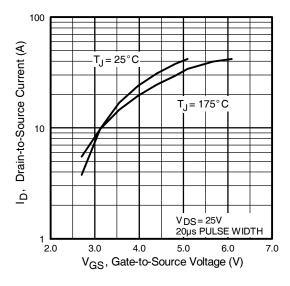


Fig 3. Typical Transfer Characteristics

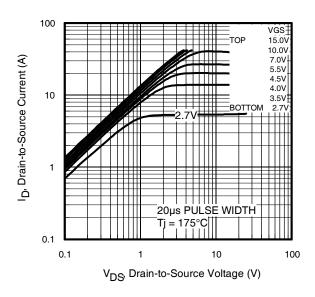


Fig 2. Typical Output Characteristics

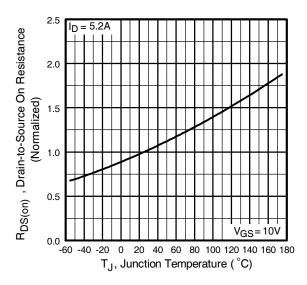


Fig 4. Normalized On-Resistance Vs. Temperature



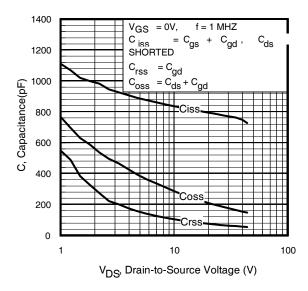


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

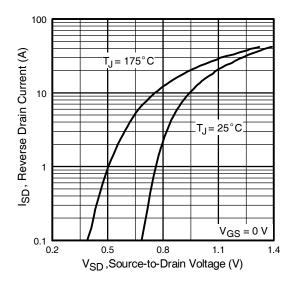


Fig 7. Typical Source-Drain Diode Forward Voltage

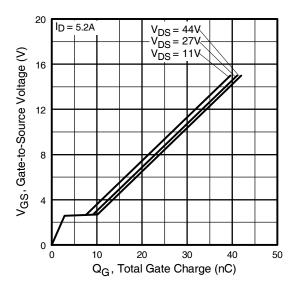


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

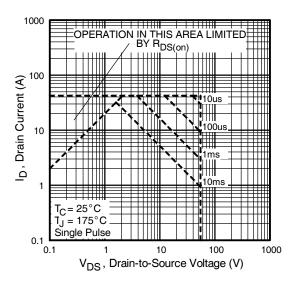


Fig 8. Maximum Safe Operating Area



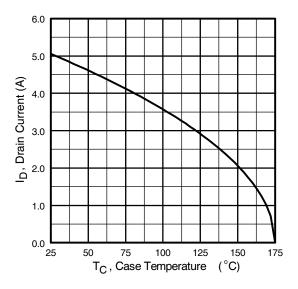


Fig 9. Maximum Drain Current Vs. Case Temperature

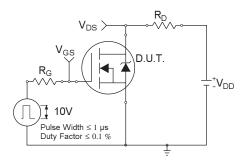


Fig 10a. Switching Time Test Circuit

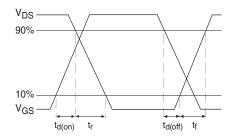


Fig 10b. Switching Time Waveforms

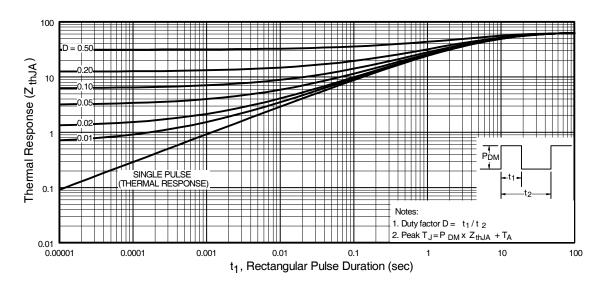


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



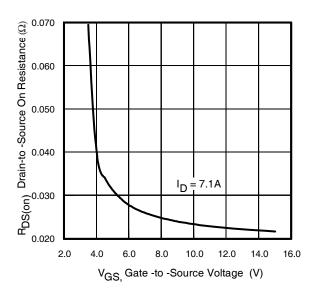


Fig 11. Typical On-Resistance Vs. Gate Voltage

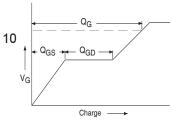


Fig 13a. Basic Gate Charge Waveform

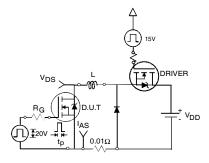


Fig 14a. Unclamped Inductive Test Circuit

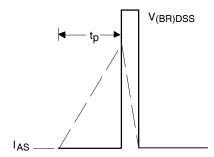


Fig 14b. Unclamped Inductive Waveforms

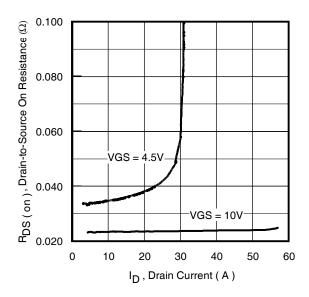


Fig 12. Typical On-Resistance Vs.
Drain Current

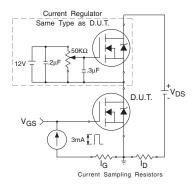


Fig 13b. Gate Charge Test Circuit

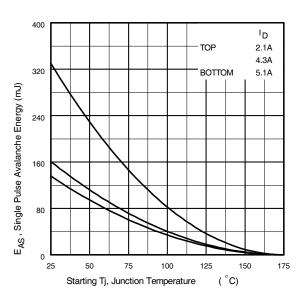


Fig 15. Maximum Avalanche Energy Vs. Drain Current



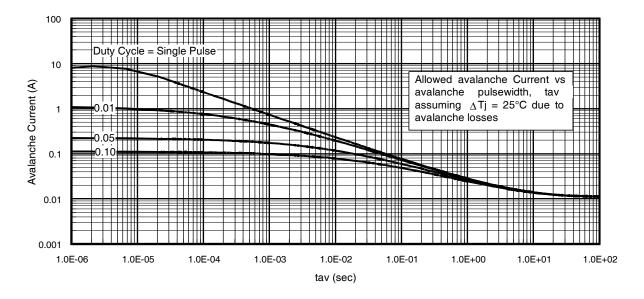


Fig 16. Typical Avalanche Current Vs. Pulsewidth

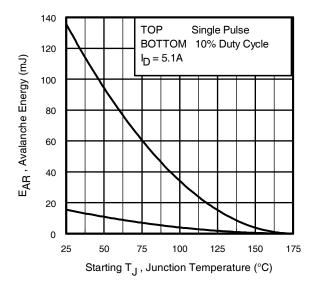


Fig 17. Maximum Avalanche Energy Vs. Temperature

Notes on Repetitive Avalanche Curves , Figures 16, 17: (For further info, see AN-1005 at www.irf.com)

- 1. Avalanche failures assumption:
 - Purely a thermal phenomenon and failure occurs at a temperature far in excess of T_{jmax} . This is validated for every part type.
- 2. Safe operation in Avalanche is allowed as long $asT_{j\max}$ is not exceeded.
- 3. Equation below based on circuit and waveforms shown in Figures 14a, 14b.
- P_{D (ave)} = Average power dissipation per single avalanche pulse.
- 5. BV = Rated breakdown voltage (1.3 factor accounts for voltage increase during avalanche).
- 6. I_{av} = Allowable avalanche current.
- 7. ΔT = Allowable rise in junction temperature, not to exceed T_{jmax} (assumed as 25°C in Figure 15, 16).

 t_{av} = Average time in avalanche.

D = Duty cycle in avalanche = $t_{av} \cdot f$

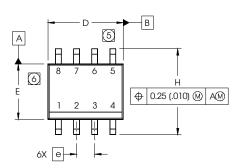
 $Z_{thJC}(D, t_{av})$ = Transient thermal resistance, see figure 11)

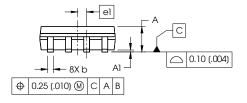
$$\begin{split} P_{D \text{ (ave)}} &= 1/2 \text{ (} 1.3 \cdot \text{BV} \cdot \text{I}_{aV} \text{)} = \triangle \text{T/Z}_{thJC} \\ I_{av} &= 2\triangle \text{T/ [} 1.3 \cdot \text{BV} \cdot \text{Z}_{th} \text{]} \\ E_{AS \text{ (AR)}} &= P_{D \text{ (ave)}} \cdot t_{av} \end{split}$$



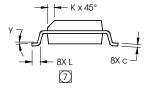
SO-8 Package Outline

Dimensions are shown in millimeters (inches)



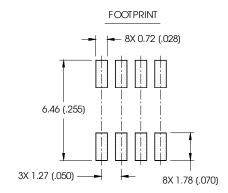


DIM	INC	HES	MILLIM	ETERS
DIIVI	MIN	MAX	MIN	MAX
Α	.0532	.0688	1.35	1.75
Al	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
С	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
Е	.1497	.1574	3.80	4.00
е	.050 BASIC		1.27 BASIC	
еl	.025 B	ASIC	0.635 E	BASIC
Н	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
У	0°	8°	0°	8°

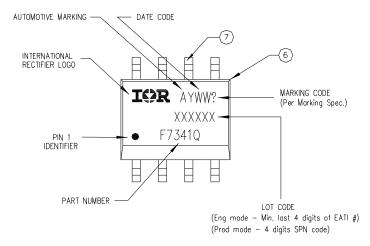


NOTES:

- 1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
- 2. CONTROLLING DIMENSION: MILLIMETER
- 3. DIMENSIONS ARE SHOWN IN MILLIMETERS (INCHES).
- 4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
- (5) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 (.006).
- (6) DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 (.010).
- (7) DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.



SO-8 Part Marking



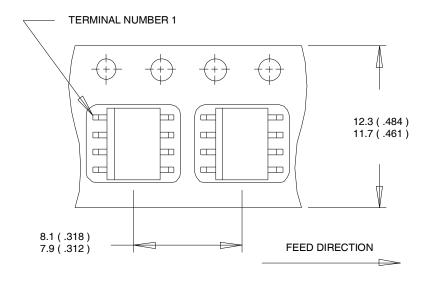
TOP MARKING (LASER)

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



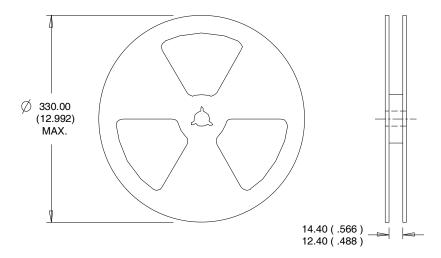
SO-8 Tape and Reel

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. ALL DIMENSIONS ARE SHOWN IN MILLIMETERS(INCHES).
- 3. OUTLINE CONFORMS TO EIA-481 & EIA-541.



NOTES:

- 1. CONTROLLING DIMENSION: MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package/



Qualification Information[†]

		Automotive (per AEC-Q101) ††				
Qualification L	.evel	Comments: This part number(s) passed Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher Automotive level.				
Moisture Sens	itivity Level	SO-8	MSL1			
	Machine Model	Class M2(+/-200V) ^{†††} (per AEC-Q101-002)				
ESD	Human Body Model	Class H1A(+/-500V) ^{†††} (per AEC-Q101-001)				
	Charged Device Model	Class C5(+/-1125V) ^{†††} (per AEC-Q101-005)				
RoHS Complia	ınt	Yes				

[†] Qualification standards can be found at International Rectifier's web site: http://www.irf.com/

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^{††} Exceptions (if any) to AEC-Q101 requirements are noted in the qualification report.

^{†††} Highest passing voltage



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WORLDHEADQUARTERS:

101N.Sepulveda Blvd, El Segundo, California 90245 Tel: (310) 252-7105



Revision History

Date	Comments			
3/10/2014	Added "Logic Level Gate Drive" bullet in the features section on page 1			
	Updated data sheet with new IR corporate template			

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